

ZZ4 ■ This Assembly Note will show in the PcbDoc and associated output

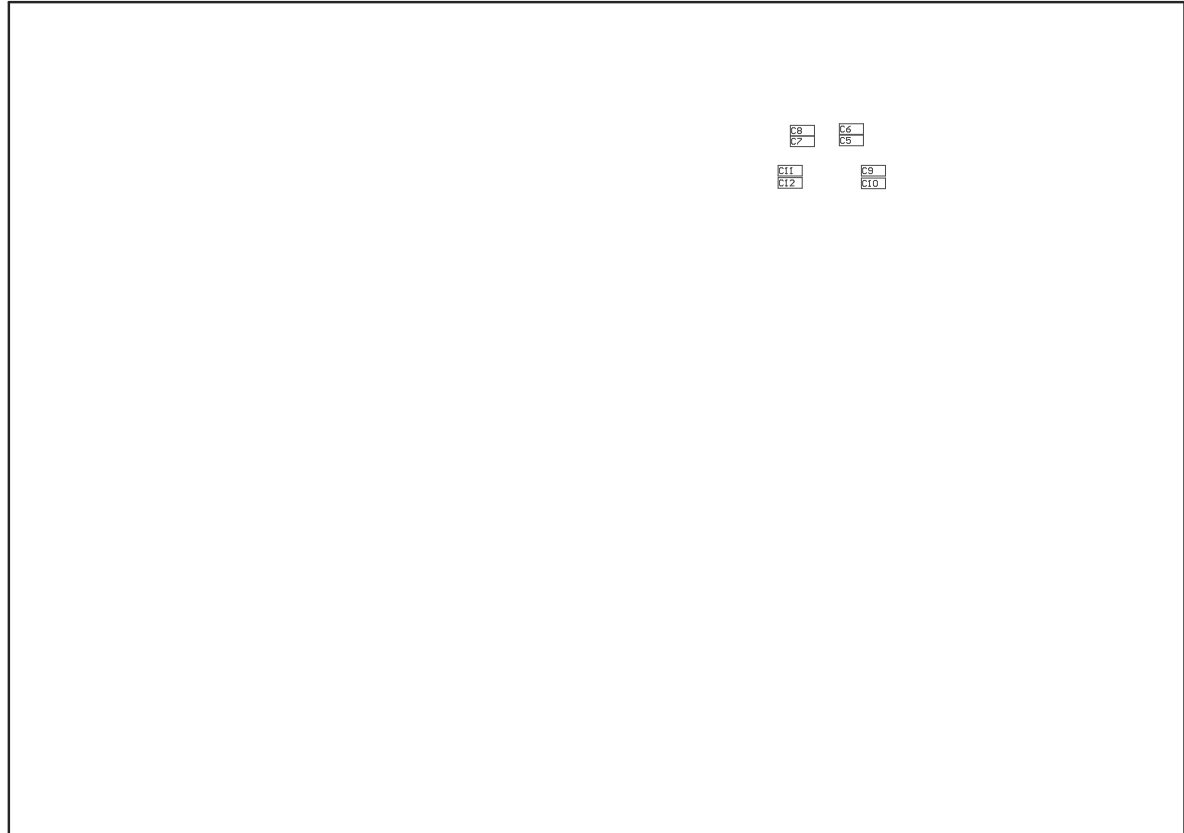
ZZ3 ■ This Assembly Note will show in the PcbDoc and associated output

ZZ2 ■ This Assembly Note will show in the PcbDoc and associated output

ZZ1 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-010013	REV: E2	SUN REV: Not In VersionControl
	TID #: N/A		
PLOT NAME = Top Assembly Drawing	GENERATED : 6/21/2018 10:39:29 AM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-010013	REV: E2	SUN REV: Not In VersionControl
	TID #: N/A		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 6/21/2018 10:39:30 AM		TEXAS INSTRUMENTS

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